

Characterizations of C₆₀ Films by Measuring Internal Friction

内部摩擦測定による C₆₀ 薄膜の物性評価

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1. Introduction

Due to high symmetry of C₆₀ molecule and weak van-der-Waals interaction between them in crystal phase, solid C₆₀ exhibits various properties with varying temperature. An elastic anomaly of solid C₆₀ at around 160 K has been observed on temperature dependences of the sound velocity and the internal friction. This anomaly is considered to correspond to C₆₀ jumping between inequivalent orientations¹. It is well known that a structural phase transition between sc and fcc appears in C₆₀ crystals around 260 K. This phase transition has been revealed in many measurements such as x-ray diffraction², sound velocity^{1,3}, dielectric constant⁴, electrical conductivity⁵, NMR⁶, and thermal conductivity⁷. At temperatures higher than 300 K Vickers hardness of C₆₀ crystal showed an anomalous behavior that the hardness increases with increasing temperature and reached a maximum at around 370 K⁸. The calorimetric measurement also showed a slightly hysteretic properties of specific heat of C₆₀ crystal in the temperature range of 310~370 K⁹. Moreover, the properties of C₆₀ crystal at around 420 K were also been studied by several groups. Raman scattering study showed that above 400 K the pentagonal pinch mode changes in frequency and becomes sharp compared with that at room temperature¹⁰. This result indicates that partial orientational order remained above 260 K and only above 400 K the C₆₀ molecules rotate freely and isotropically. Calorimetric measurement showed that there was a peak of heat capacity in C₆₀ crystal at 425 K⁹. The internal friction measured by means of the free-free bar apparatus showed that a λ -shaped peak was detected in C₆₀ films at 426 K¹¹. The capacitance and dissipation factor curves have a pronounced feature at 435 K, confirming a phase transition above 400 K¹².

In this study, the C₆₀ films are grown on Si substrate by means of evaporating C₆₀ powder in

vacuum. The internal friction of the C₆₀/Si sample is measured by reed-vibrating method, in which electrostatic drive and laser displacement sensor are used. We also calculated several crystallographic parameters of C₆₀ crystal as a function of temperature. By comparing the theoretical and experimental results, the structural and dynamic properties of C₆₀ molecules in crystal phase will be discussed.

2. Experimental

The C₆₀ films were deposited on the Si substrate of 40×5×x mm³ at 473 K by sublimation in vacuum with residual gas pressure below 2.0×10⁻⁶ Torr. The thickness of the C₆₀ films on the Si substrate was about 0.5 μ m. The internal friction of C₆₀ films was evaluated by subtracting the internal friction of Si substrate from that of the C₆₀ film/Si substrate sample.

3. Results and Discussion

Figure 1 shows temperature dependences of internal friction of C₆₀ films in the temperature range of 100~500 K for two frequencies of 224 and 444 Hz. Several peaks of the internal friction are observed. Except the peak 4, they shift to higher temperatures with increasing frequency. The peaks 1 and 2 are attributed to relaxation processes of C₆₀ molecule between different orientations in sc lattice. The peak 3 is due to order-disorder phase transition corresponding to sc and fcc structures. The peak 4 at 360 K is from Si substrate, and independent of frequency. The peak 5 is related to a transition between solid and 'liquid' phases because of the evaporation temperature of 460 K for C₆₀ crystal.

In order to clarify mechanisms of the internal friction happened in the C₆₀ films, we calculated both diameter and nearest-neighbor distance of C₆₀ molecules in sc and fcc crystal as a function of temperature. The results obtained are shown in Fig. 2. These values are defined as follows:

$$\delta D(T) = D(T) - D_0, \quad \delta d(T) = d(T) - d_0$$

where D_0 and d_0 is diameter and nearest-neighbor

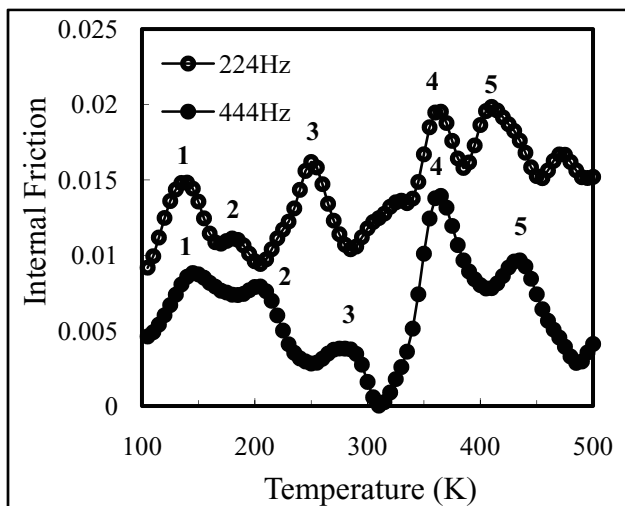


Fig. 1 Temperature dependences of the internal friction of C_{60} films. The open and closed circles represent the results measured at frequencies of 224 Hz and 444 Hz, respectively.

distance of C_{60} molecules at 0 K, respectively. Also, we used that $d(T) = 1.4154/\sqrt{2} = 1.001$ nm and $D(T) = 0.71$ nm at temperature of 270 K. Except a sharp variation at about 260 K, δd is proportional to temperature. On the other hand, there is a minimum of δD at about 150 K. The difference between δd and δD shows several special points at temperature, below 100 K, around 150 K, at 260 K and above 260 K. Below 100 K the decrease in the $\delta d - \delta D$ results in a glassy phase in the C_{60} film. In the range of 150 ~ 200 K, the large difference between δd and δD is advantageous to orientational order relaxation of C_{60} molecules. Around 260 K the sc-fcc structural phase transition can be certainly detected by measuring internal friction. The decrease of the $\delta d - \delta D$ above 260 K, leading to the solid~liquid phase transition, results in a peak around 420 K for internal friction.

4. Conclusion

The internal friction of the C_{60}/Si sample was measured by using reed-vibrating method. Several relaxation peaks were observed on the temperature dependence of internal friction of C_{60} film. These relaxation processes are related to the variation in both the diameter and the nearest-neighbor distance of C_{60} molecules in crystal phase.

Acknowledgment

This work was partially supported by Program of Research for Promotion Technological Seeds (B), Japan Science and Technology Agency (JST).

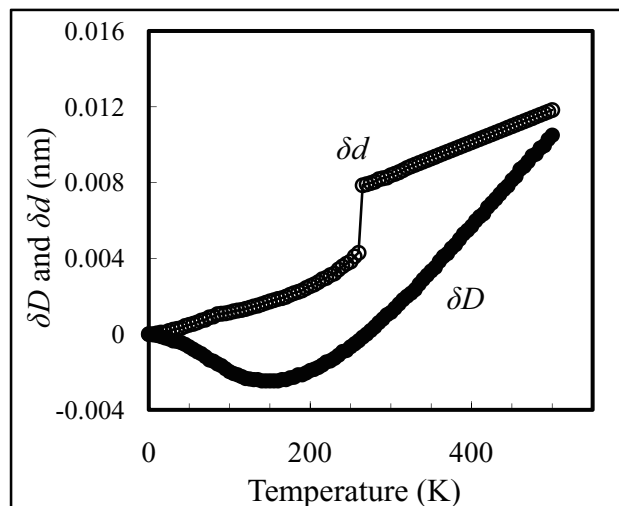


Fig. 2 The diameter (δD) and the nearest-neighbor distance (δd) of C_{60} molecules in sc and fcc crystal phases as a function of temperature.

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